

5th International Conference on Materials For Advanced Technologies 2009

28th June – 3rd July 2009, Singapore Suntec Singapore International Convention & Exhibition Centre Organized by The Materials Research Society of Singapore

ICMAT 2009 – Sponsorship Application/Contract

This application must be received by the ICMAT 2009 Secretariat on or before 31 January 2009, along with payment for the total cost of the sponsorship to the address stated at the bottom of page 2.

Application Due Date: 31 January 2009

Company Details (into	ormation to be listed on the conference website and Program & Abstracts Book)
Company Name	
Address	
City / State	Postal Code
Telephone	Fax
Email	
Website	
Company/Product/Service Description (50 words or less)	

Company Representative (to receive information/updates on ICMAT 2009)

Name	(Prof/ Dr/ Mr/ Mdm/ Ms)
Title	
Telephone	(Office) (Mobile) Fax
Email address	

Sponsorship Category

Туре	Amount (SGD)	Amount Payable
Premier Sponsor	60,000	
Grand Sponsor	40,000	
Major Sponsor	25,000	
Privileged Sponsor	15,000	
Sponsor	6,000	
Supporter	3,000	
Others (Please specify:		
	TOTAL	



Date Received

Processed by

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Sponsorship Contract

By submitting this Sponsorship Contract, The Company, named on Page 1 of this document (herein referred to as "The Company") agrees to sponsor the stated amount to ICMAT 2009 to be held 29th June – 1st July 2009, at the Suntec Singapore International Convention & Exhibition Centre, Singapore. The Company agrees to pay the ICMAT 2009 Organising Committee for the said sponsorship amount in accordance with the terms and conditions outlined in the Sponsorship Prospectus, and understand that, once accepted by the ICMAT 2009 Organising Committee, this document constitutes a valid and binding contract between ICMAT 2009 Organising Committee and The Company. The Company agrees to comply with all instructions, rules, and regulations as set out herein.

I, the duly authorized representative of The Company, on behalf of The Company, subscribe and agree to all the terms, conditions, authorizations, and covenants contained in the ICMAT 2009 Sponsorship Prospectus.

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Name (in capital lette	rs):		
Designation:			
Signature Date:	Company Stamp		
PAYMENT DETAIL	LS ubmitted will only be confirmed upon receipt of payment)		
☐ Cheque enclos	red (made payable to "MRS Singapore - ICMAT 2009") \$		
Bank	Cheque No		
	(with all bank charges prepaid) pank transfer document together with this application form for verification of bank transfer		
Account Name Account Number			
Bank Name			
Address SWIFT Code	: Clementi Branch, Blk 450 Clementi Ave 3, #01-293/295 Singapore 120450 : DBSSSGSG		
	ooth sides of this form for your records. A confirmation letter will be sent to you upon		
	pleted application form and payment should be mailed/faxed to: ICMAT 2009 Secretariat		
	Materials Research Society (Singapore)		
	c/o Integrated Meetings Specialist Pte Ltd		
I	Block 998 Toa Payoh North #07-18/19 Singapore 318993 FAX: (65) 6356 7471		
FOR OFFICIAL USE (DO) NOT ENTER)		

Sponsorship allocation

Receipt No. Issued